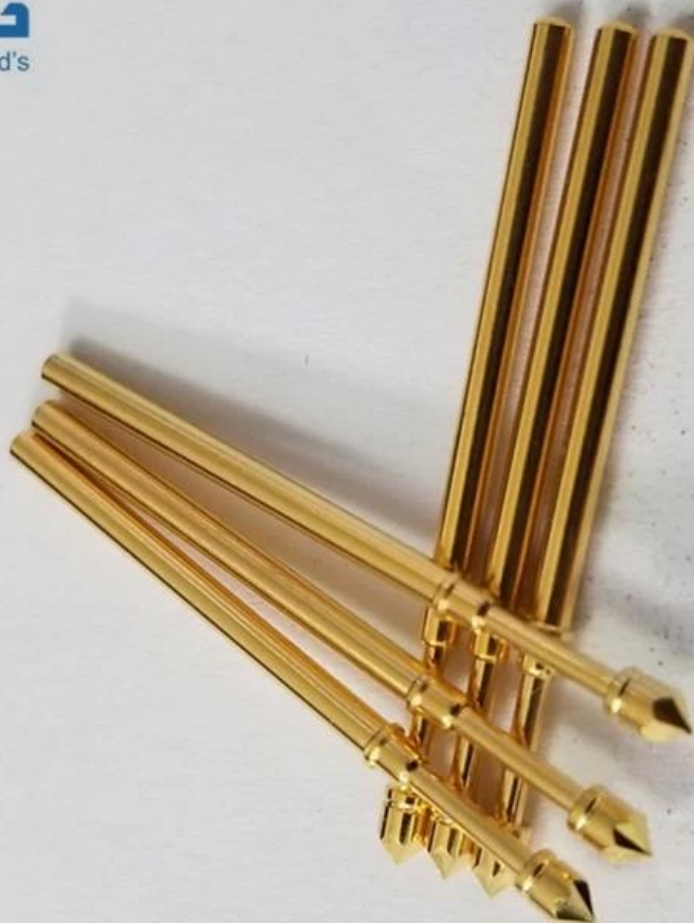


100mil ICT板规格书SF-PA1.65 BY 32.3-LM2.0

一、

名称	SFENG
规格	SF-PA1.65X32.3-LM2.0
材料	BeCu
厚度	0.15mm
表面处理	SWP
重量	350g±50g
孔径	4.0mm
孔距	2.54mm
阻焊厚度	50mΩ
测试电压	5A
测试电流	5.30mm
MOQ	1000
包装方式	防静电袋7-15个

二、



□□□□□□□□□□□□□□□□



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products

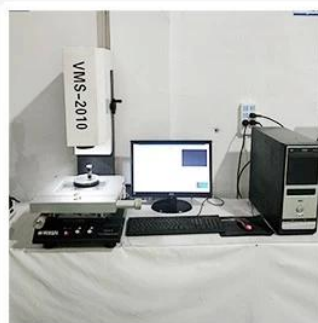


6. Packing

□□□□



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

□□□□□

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

